勝 特 力 材 料 886-3-5753170 胜特力电子(上海) 86-21-54151736 胜特力电子(深圳) 86-755-83298787 Http://www.100y.com.tw



SBVS025G – SEPTEMBER 2001 – REVISED SEPTEMBER 2005

DMOS 1A Low-Dropout Regulator

FEATURES

- NEW DMOS TOPOLOGY:
 Ultra Low Dropout Voltage:
 230mV typ at 1A and 3.3V Output
 Output Capacitor NOT Required for Stability
- FAST TRANSIENT RESPONSE
- VERY LOW NOISE: 33µV_{RMS}
 HIGH ACCURACY: ±2% max
- ◆ HIGH EFFICIENCY: I_{GND} = 1.7mA at I_{OUT} = 1A Not Enabled: I_{GND} = 0.5µA
- 2.5V, 2.7V, 3.0V, 3.3V, 5.0V AND ADJUSTABLE OUTPUT VERSIONS
- THERMAL PROTECTION
- SMALL SURFACE-MOUNT PACKAGES: SOT223-5, DDPAK-5

APPLICATIONS

- PORTABLE COMMUNICATION DEVICES
- BATTERY-POWERED EQUIPMENT
- MODEMS
- BAR-CODE SCANNERS
- BACKUP POWER SUPPLIES

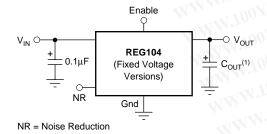
DESCRIPTION

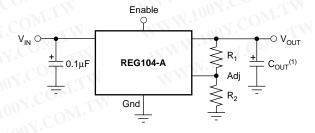
The REG104 is a family of low-noise, low-dropout linear regulators with low ground pin current. Its new DMOS topology provides significant improvement over previous designs, including low dropout voltage (only 230mV typ at full load), and better transient performance. In addition, no output capacitor is required for stability, unlike conventional low dropout regulators that are difficult to compensate and require expensive low ESR capacitors greater than 1µF.

Typical ground pin current is only 1.7mA (at $I_{OUT} = 1A$) and drops to 0.5 μ A in *not enabled* mode. Unlike regulators with PNP pass devices, quiescent current remains relatively constant over load variations and under dropout conditions.

The REG104 has very low output noise (typically $33\mu V_{RMS}$ for $V_{OUT}=3.3V$ with $C_{NR}=0.01\mu F$), making it ideal for use in portable communications equipment. On-chip trimming results in high output voltage accuracy. Accuracy is maintained over temperature, line, and load variations. Key parameters are tested over the specified temperature range (-40°C to +85°C).

The REG104 is well protected—internal circuitry provides a current limit which protects the load from damage. Thermal protection circuitry keeps the chip from being damaged by excessive temperature. The REG104 is available in the DDPAK-5 and the SOT223-5.





NOTE: (1) Optional



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

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ABSOLUTE MAXIMUM RATINGS(1)

Supply Input Voltage, V _{IN}	0.3V to 16V
Enable Input Voltage, V _{EN}	–0.3V to V _{IN}
Feedback Voltage, V _{FB}	0.3V to 6.0V
NR Pin Voltage, V _{NR}	0.3V to 6.0V
Output Short-Circuit Duration	Indefinite
Operating Temperature Range	55°C to +125°C
Storage Temperature Range	65°C to +150°C
Junction Temperature	–55°C to +150°C
Lead Temperature (soldering, 3s, SOT, and DDPAK)	+240°C
ESD Rating: HBM (V _{OUT} to GND)	1.5kV
HBM (All other pins)	2kV
CDM	500V
	4.4

NOTE: (1) Stresses above these ratings may cause permanent damage. Exposure to absolute maximum conditions for extended periods may degrade device reliability.

ELECTROSTATIC DISCHARGE SENSITIVITY

This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

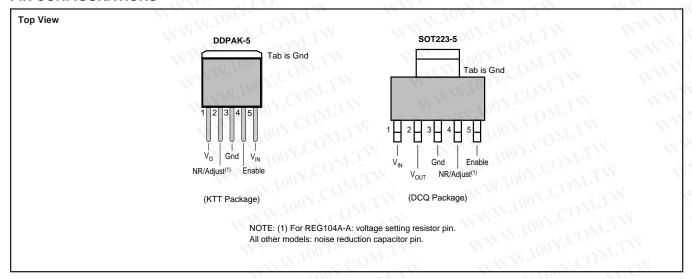
ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

PACKAGE/ORDERING INFORMATION(1)

PRODUCT	V _{out}
REG104xx-yyyy/zzz	XX is package designator.
M. 100 r. COW. I.	YYYY is typical output voltage (5 = 5.0V, 2.85 = 2.85V, A = Adjustable).
WWW. 100Y. CONTY	ZZZ is package quantity.

(1) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI website at www.ti.com.

PIN CONFIGURATIONS





ELECTRICAL CHARACTERISTICS

Boldface limits apply over the specified temperature range, $T_J = -40^{\circ}C$ to $+85^{\circ}C$

At T_J = +25°C, V_{IN} = V_{OUT} + 1V (V_{OUT} = 3.0V for REG104-A), V_{ENABLE} = 2V, I_{OUT} = 10mA, C_{NR} = 0.01 μ F, and C_{OUT} = 0.1 μ F(1), unless otherwise noted.

W.100Y.COM.TW		WW.1001.COM.TW	V	· N			
PARAMETER		CONDITION	MIN	TYP MAX		UNITS	
OUTPUT VOLTAGE Output Voltage Range REG104-2.5 REG104-2.7 REG104-3.0 REG104-5 REG104-A Reference Voltage Adjust Pin Current Accuracy T _J = -40°C to +85°C vs Temperature vs Line and Load T _J = -40°C to +85°C	V _{REF} I _{ADJ}	$T_J = -40^{\circ}\text{C to } +85^{\circ}\text{C}$ $I_{OUT} = 10\text{mA to } 1\text{A}, V_{IN} = (V_{OUT} + 0.7\text{V}) \text{ to } 15\text{V}$ $V_{IN} = (V_{OUT} + 0.9\text{V}) \text{ to } 15\text{V}$	V _{REF}	2.5 2.7 3.0 3.3 5 1.295 0.2 ±0.5 70 ±0.5	5.5 1 ±2 ±3.0 ±2.5 ±3.5	V V V V V μA % ppm/°C %	
DC DROPOUT VOLTAGE(2, 3) For all models except 5V For 5V model For all models except 5V $T_J = -40^{\circ}C$ to +85°C For 5V models $T_J = -40^{\circ}C$ to +85°C	V _{DROP}	I _{OUT} = 10mA I _{OUT} = 1A I _{OUT} = 1A I _{OUT} = 1A I _{OUT} = 1A	M.TW OM.TW	3 230 320	25 400 500 480 580	mV mV mV mV	
VOLTAGE NOISE f = 10Hz to 100kHz Without C _{NR} (all models) With C _{NR} (all fixed voltage models)	V _n	$C_{NR} = 0, C_{OUT} = 0$ $C_{NR} = 0.01 \mu F, C_{OUT} = 10 \mu F$	35	μV _{RMS} μV _{RMS}			
OUTPUT CURRENT Current Limit ⁽⁴⁾ $T_J = -40^{\circ}\text{C to } +85^{\circ}\text{C}$	I _{CL}	CONTA MANTO	1.2 1.0	1.7	2.1 2.2	A A	
RIPPLE REJECTION f = 120Hz	TV 100	V.CO.W.IM MM.I	00X.C	65	N	dB	
ENABLE CONTROL V _{ENABLE} High (output enabled) V _{ENABLE} Low (output disabled) I _{ENABLE} High (output enabled) I _{ENABLE} Low (output disabled) Output Disable Time Output Enable Softstart Time	V _{ENABLE}	V_{ENABLE} = 2V to V_{IN} , V_{IN} = 2.1V to 6.5 ⁽⁵⁾ V_{ENABLE} = 0V to 0.5V	2 -0.2	1 2 50 1.5	V _{IN} 0.5 100 100	V V nA nA μs ms	
THERMAL SHUTDOWN Junction Temperature Shutdown Reset from Shutdown	WWW	W.100X'COW'LM MA	M.1001	150 130	TW TW	°C	
GROUND PIN CURRENT Ground Pin Current Enable Pin Low	I _{GND}	$I_{OUT} = 10\text{mA}$ $I_{OUT} = 1\text{A}$ $V_{ENABLE} \le 0.5\text{V}$	MMM'TO	0.5 1.7 0.5	0.7 1.8	mA mA μA	
INPUT VOLTAGE Operating Input Voltage Range ⁽⁶⁾ Specified Input Voltage Range T _J = -40°C to +85°C	V _{IN}	V _{IN} > 2.7V V _{IN} > 2.9V	2.1 V _{OUT} + 0.7 V _{OUT} + 0.9	.100 ^{Y.CC}	15 15 15	V V V	
TEMPERATURE RANGE Specified Range Operating Range Storage Range Thermal Resistance	TJ	WWW.100Y.COM.TW	-40 -55 -65	W.100Y	+85 +125 +150	o° o° o°	
DDPAK-5 Surface Mount SOT223-5 Surface Mount	$ heta_{ extsf{JC}}$	Junction-to-Case Junction-to-Case	W	4 15	Y.Com	°C/W	

NOTES: (1) The REG104 does not require a minimum output capacitor for stability. However, transient response can be improved with proper capacitor selection.

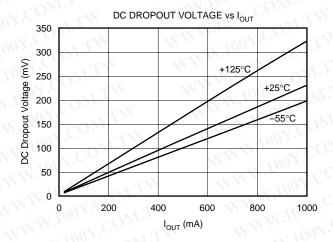
- (2) Dropout voltage is defined as the input voltage minus the output voltage that produces a 2% change in the output voltage from the value at V_{IN} = V_{OUT} + 1V at fixed load.
- (3) Not applicable for $V_{\rm OUT}$ less than 2.7V.
- (4) Current limit is the output current that produces a 15% change in output voltage from $V_{IN} = V_{OUT} + 1V$ and $I_{OUT} = 10$ mA.
- (5) For $V_{IN} > 6.5V$, see typical characteristic V_{ENABLE} vs I_{ENABLE} .
- (6) The REG104 no longer regulates when V_{IN} < V_{OUT} + V_{DROP (MAX)}. In drop-out or when the input voltage is between 2.7V and 2.1V, the impedance from V_{IN} to V_{OUT} is typically less than 1Ω at T_J = +25°C. See typical characteristic *Output Voltage Change vs V_{IN}*.

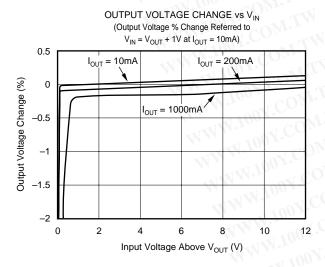


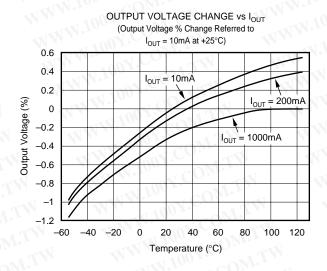
TYPICAL CHARACTERISTICS

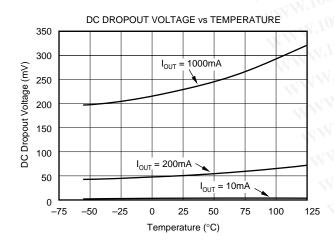
For all models, at T_J = +25°C and V_{ENABLE} = 2V, unless otherwise noted.

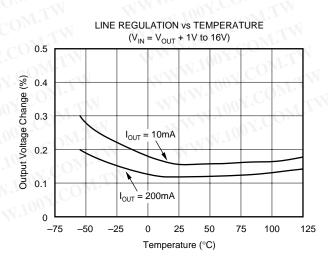
OUTPUT VOLTAGE CHANGE vs I_{OUT} (V_{IN} = V_{OUT} + 1V, Output Voltage % Change Referred to I_{OUT} = 10mA at +25°C) 0.8 0.6 +125°C Output Voltage Change (%) 0.4 0.2 0 +25°C -0.2 -0.4 -0.6 -0.8–55°C -1 0 100 200 300 400 500 600 700 800 900 1000 Output Current (mA)







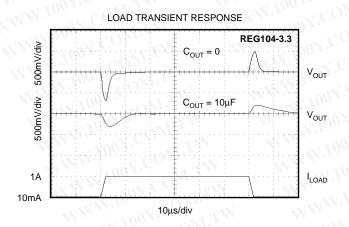


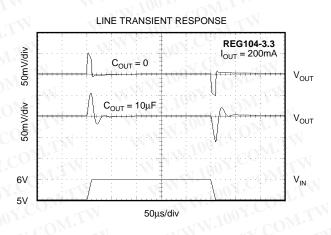


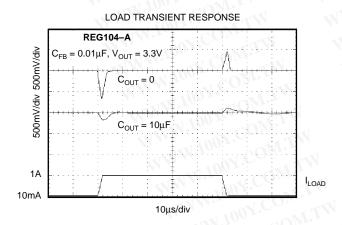


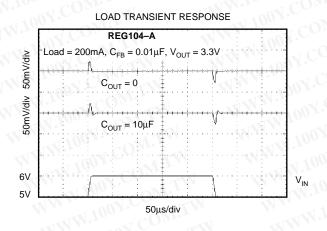
TYPICAL CHARACTERISTICS (Cont.)

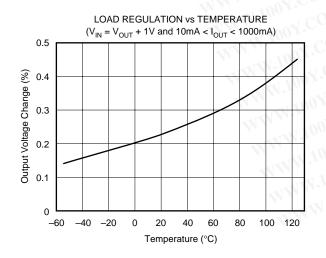
For all models, at T_J = +25°C and V_{ENABLE} = 2V, unless otherwise noted.

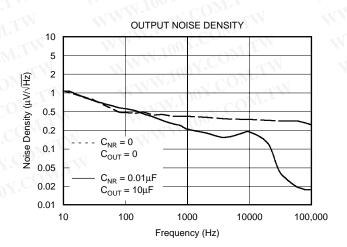










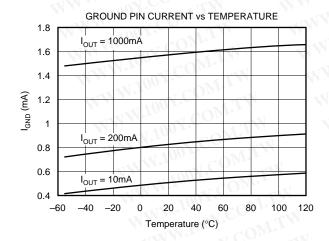


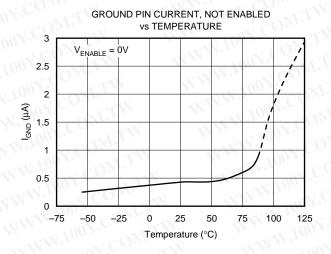


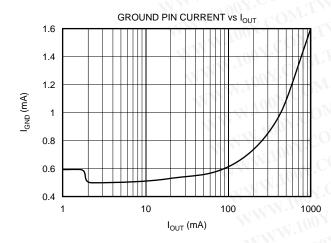


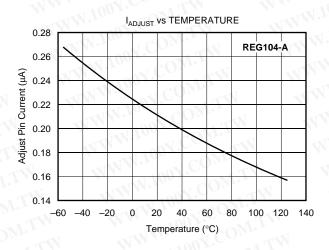
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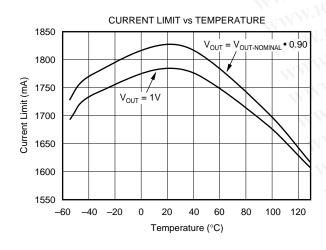
For all models, at T_J = +25°C and V_{ENABLE} = 2V, unless otherwise noted.

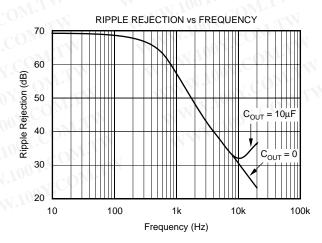








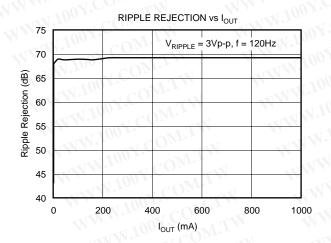


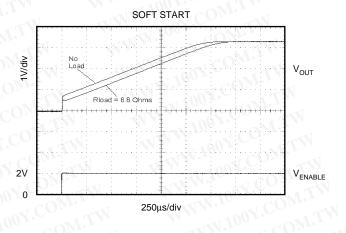


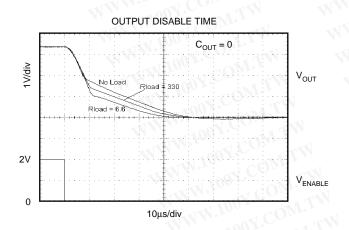


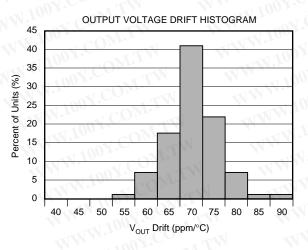
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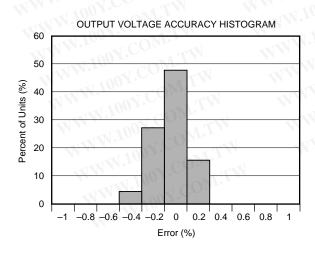
For all models, at T_J = +25°C and V_{ENABLE} = 2V, unless otherwise noted.















BASIC OPERATION

The REG104 series is a family of LDO (Low DropOut) linear regulators. The family includes five fixed output versions (2.5V to 5.0V) and an adjustable output version. An internal DMOS power device provides low dropout regulation with near constant ground pin current (largely independent of load and dropout conditions) and very fast line and load transient response. All versions include internal current limit and thermal shutdown circuitry.

Figure 1 shows the basic circuit connections for the fixed voltage models. Figure 2 gives the connections for the adjustable output version (REG104A) and example resistor values for some commonly used output voltages. Values for other voltages can be calculated from the equation shown in Figure 2.

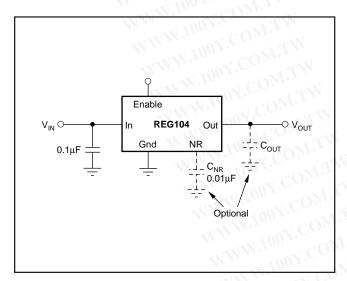


FIGURE 1. Fixed Voltage Nominal Circuit for REG104.

None of the versions require an output capacitor for regulator stability. The REG104 will accept any output capacitor type less than $1\mu F$. For capacitance values larger than $1\mu F$ the effective ESR should be greater than $0.1\Omega.$ This minimum ESR value includes parasitics such as printed circuit board traces, solder joints, and sockets. A minimum $0.1\mu F$ low ESR capacitor connected to the input supply voltage is recommended.

ENABLE

The Enable pin allows the regulator to be turned on and off. This pin is active HIGH and compatible with standard TTL-CMOS levels. Inputs below 0.5V (max) turn the regulator off and all circuitry is disabled. Under this condition ground-pin current drops to approximately $0.5\mu A$.

When not used, the Enable pin may be connected to V_{IN} . Internal to the part, the Enable pin is connected to an input resistor-zener diode circuit, as shown in Figure 3, creating a nonlinear input impedance.

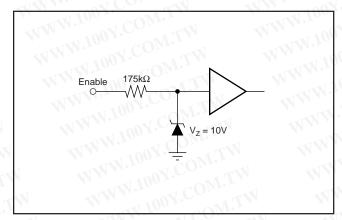
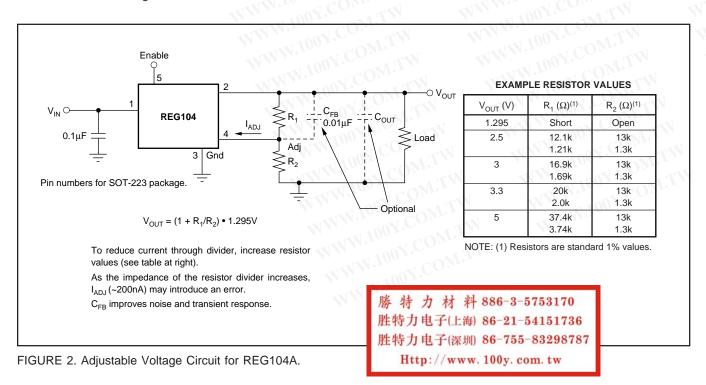


FIGURE 3. Enable Pin Equivalent Input Circuit.



The Enable Pin Current versus Applied Voltage relationship is shown in Figure 4. When the Enable pin is connected to V_{IN} greater than 10V, a series resistor may be used to limit the current.

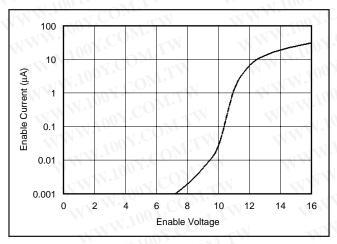


FIGURE 4. Enable Pin Current versus Applied Voltage.

OUTPUT NOISE

A precision band-gap reference is used for the internal reference voltage, V_{REF} , for the REG104. This reference is the dominant noise source within the REG104. It generates approximately $45\mu V_{RMS}$ in the 10Hz to 100kHz bandwidth at the reference output. The regulator control loop gains up the reference noise, so that the noise voltage of the regulator is approximately given by:

$$V_N = 45 \mu V_{RMS} \, \frac{R_1 + R_2}{R2} = 45 \mu V_{RMS} \, \bullet \frac{V_{OUT}}{V_{REF}} \label{eq:VN}$$

Since the value of V_{REF} is 1.295V, this relationship reduces to:

$$V_N = 35 \frac{\mu V_{RMS}}{V} \bullet V_{OUT}$$

Connecting a capacitor, C_{NR} , from the Noise-Reduction (NR) pin to ground can reduce the output noise voltage. Adding C_{NR} , as shown in Figure 5, forms a low-pass filter for the voltage reference. For $C_{NR}=10$ nF, the total noise in the 10Hz to 100kHz bandwidth is reduced by approximately a factor of 3.5. This noise reduction effect is shown in Figure 6.

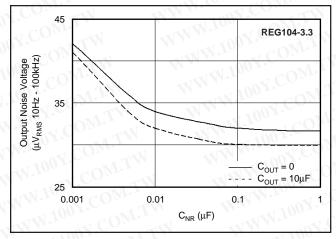


FIGURE 6. Output Noise versus Noise Reduction Capacitor.

The REG104 adjustable version does not have the noise-reduction pin available, however, the adjust pin is the summing junction of the error amplifier. A capacitor, C_{FB} ,

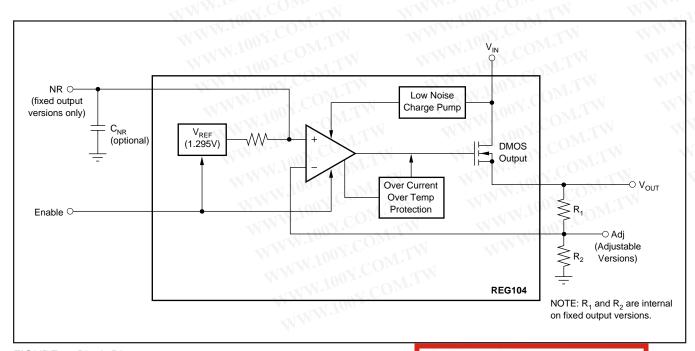


FIGURE 5. Block Diagram.



connected from the output to the adjust pin will reduce both the output noise and the peak error from a load transient. Figure 7 shows improved output noise performance for two capacitor combinations.

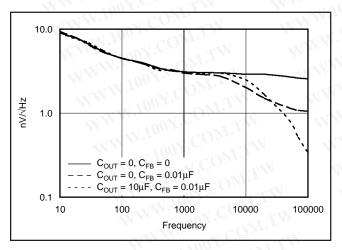


FIGURE 7. Output Noise Density on Adjustable Versions.

The REG104 utilizes an internal charge pump to develop an internal supply voltage sufficient to drive the gate of the DMOS pass element above V_{IN} . The charge-pump switching noise (nominal switching frequency = 2MHz) is not measurable at the output of the regulator.

DROP-OUT VOLTAGE

The REG104 uses an N-channel DMOS as the *pass* element. When the input voltage is within a few hundred millivolts of the output voltage, the DMOS device behaves like a resistor. Therefore, for low values of V_{IN} to V_{OUT} , the regulator's input-to-output resistance is the Rds_{ON} of the DMOS pass element (typically $230\text{m}\Omega$). For static (DC) loads, the REG104 will typically maintain regulation down to V_{IN} to V_{OUT} voltage drop of 230mV at full rated output current. In Figure 8, the bottom line (DC dropout) shows the minimum V_{IN} to V_{OUT} voltage drop required to prevent dropout under DC load conditions.

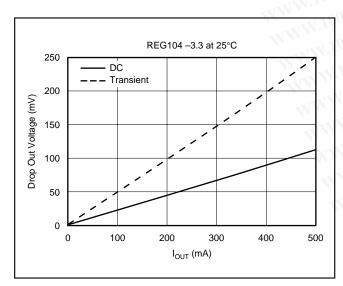


FIGURE 8. Transient and DC Dropout.

For large step changes in load current, the REG104 requires a larger voltage drop across it to avoid degraded transient response. The boundary of this *transient dropout* region is shown as the top line in Figure 8. Values of $V_{\rm IN}$ to $V_{\rm OUT}$ voltage drop above this line insure normal transient response.

In the transient dropout region between *DC* and *Transient*, transient response recovery time increases. The time required to recover from a load transient is a function of both the magnitude and rate of the step change in load current and the available *headroom* V_{IN} to V_{OUT} voltage drop. Under worst-case conditions (full-scale load change with V_{IN} to V_{OUT} voltage drop close to DC dropout levels), the REG104 can take several hundred microseconds to re-enter the specified window of regulation.

TRANSIENT RESPONSE

The REG104 response to transient line and load conditions improves at lower output voltages. The addition of a capacitor (nominal value 10nF) from the output pin to ground may improve the transient response. In the adjustable version, the addition of a capacitor, C_{FB} (nominal value 10nF), from the output to the adjust pin will also improve the transient response.

THERMAL PROTECTION

Power dissipated within the REG104 will cause the junction temperature to rise. The REG104 has thermal shutdown circuitry that protects the regulator from damage. The thermal protection circuitry disables the output when the junction temperature reaches approximately 150°C, allowing the device to cool. When the junction temperature cools to approximately 130°C, the output circuitry is again enabled. Depending on various conditions, the thermal protection circuit may cycle on and off. This limits the dissipation of the regulator, but may have an undesirable effect on the load.

Any tendency to activate the thermal protection circuit indicates excessive power dissipation or an inadequate heat sink. For reliable operation, junction temperature should be limited to 125°C, maximum. To estimate the margin of safety in a complete design (including heat sink), increase the ambient temperature until the thermal protection is triggered. Use worst-case loads and signal conditions. For good reliability, thermal protection should trigger more than 35°C above the maximum expected ambient condition of your application. This produces a worst-case junction temperature of 125°C at the highest expected ambient temperature and worst-case load.

The internal protection circuitry of the REG104 has been designed to protect against overload conditions. It was not intended to replace proper heat sinking. Continuously running the REG104 into thermal shutdown will degrade reliability.



POWER DISSIPATION

The REG104 is available in two different package configurations. The ability to remove heat from the die is different for each package type and, therefore, presents different considerations in the printed circuit board (PCB) layout. The PCB area around the device that is free of other components moves the heat from the device to the ambient air. While it is difficult to impossible to quantify all of the variables in a thermal design of this type, performance data for several configurations are shown in Figure 9. In all cases the PCB copper area is bare copper, free of solder resist mask, and not solder plated. All examples are for 1-ounce copper. Using heavier copper will increase the effectiveness in moving the heat from the device. In those examples where there is copper on both sides of the PCB, no connection has been provided between the two sides. The addition of plated through holes will improve the heat sink effectiveness.

Power dissipation depends on input voltage and load conditions. Power dissipation is equal to the product of the average output current times the voltage across the output element, V_{IN} to V_{OUT} voltage drop.

$$P_D = (V_{IN} - V_{OUT}) \bullet I_{OUT(AVG)}$$

Power dissipation can be minimized by using the lowest possible input voltage necessary to assure the required output voltage.

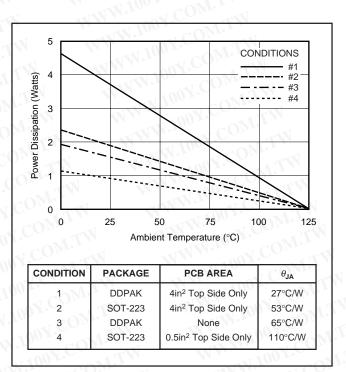


FIGURE 9. Maximum Power Dissipation versus Ambient Temperature for the Various Packages and PCB Heat Sink Configurations.



REGULATOR MOUNTING

The tab of both packages is electrically connected to ground. For best thermal performance, the tab of the DDPAK surface-mount version should be soldered directly to a circuit-board copper area. Increasing the copper area improves heat dissipation. Figure 10 shows typical thermal resistance from junction to ambient as a function of the copper area for the DDPAK. Figure 11 shows the same relationship for the SOT-223.

Although the tabs of the DDPAK and the SOT-223 are electrically grounded, they are not intended to carry any current. The copper pad that acts as a heat sink should be isolated from the rest of the circuit to prevent current flow through the device from the tab to the ground pin. Solder pad footprint recommendations for the various REG104 devices are presented in the Application Bulletin *Solder Pad Recommendations for Surface-Mount Devices* (SBFA015A), available from the Texas Instruments web site (www.ti.com).

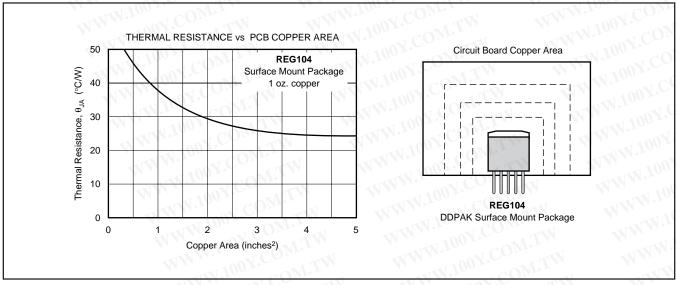


FIGURE 10. Thermal Resistance versus PCB Area for the Five-Lead DDPAK.

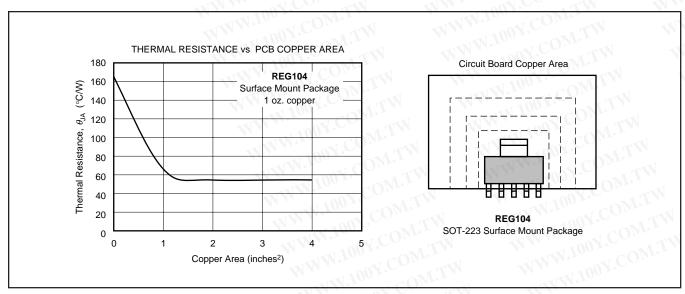


FIGURE 11. Thermal Resistance versus PCB Area for the Five Lead SOT-223.





PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	e Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
REG104FA-2.5	OBSOLETE	DDPAK/ TO-263	KTT	5	COM.	TBD	Call TI	Call TI
REG104FA-2.5/500	NRND	DDPAK/ TO-263	KTT	5	500	Green (RoHS & no Sb/Br)	Call TI	Level-2-260C-1 YEAR
REG104FA-2.5KTTT	NRND	DDPAK/ TO-263	КТТ	5	50	Green (RoHS & no Sb/Br)	Call TI	Level-2-260C-1 YEAR
REG104FA-2.7	OBSOLETE	DDPAK/ TO-263	KTT	5	on Y.C	TBD	Call TI	Call TI
REG104FA-2.7/500	ACTIVE	DDPAK/ TO-263	КТТ	5	500	Green (RoHS & no Sb/Br)	Call TI	Level-2-260C-1 YEAR
REG104FA-2.7/500G3	ACTIVE	DDPAK/ TO-263	KTT	5	500	Green (RoHS & no Sb/Br)	Call TI	Level-2-260C-1 YEAR
REG104FA-2.7KTTT	ACTIVE	DDPAK/ TO-263	KTT	5	50	Green (RoHS & no Sb/Br)	Call TI	Level-2-260C-1 YEAR
REG104FA-3	OBSOLETE	DDPAK/ TO-263	КТТ	5	N.M.10	TBD	Call TI	Call TI
REG104FA-3.3	OBSOLETE	DDPAK/ TO-263	ктт	5	WW.	TBD	Call TI	Call TI
REG104FA-3.3/500	ACTIVE	DDPAK/ TO-263	KTT	5	500	Green (RoHS & no Sb/Br)	Call TI	Level-2-260C-1 YEAR
REG104FA-3.3KTTT	ACTIVE	DDPAK/ TO-263	KTT	5	50	Green (RoHS & no Sb/Br)	Call TI	Level-2-260C-1 YEAR
REG104FA-3/500	NRND	DDPAK/ TO-263	KTT	5	500	Green (RoHS & no Sb/Br)	Call TI	Level-2-260C-1 YEAR
REG104FA-3/500G3	ACTIVE	DDPAK/ TO-263	КТТ	5	500	Green (RoHS & no Sb/Br)	Call TI	Level-2-260C-1 YEAR
REG104FA-3KTTT	NRND	DDPAK/ TO-263	Сктт	5	50 <	Green (RoHS & no Sb/Br)	Call TI	Level-2-260C-1 YEAR
REG104FA-5	OBSOLETE	DDPAK/ TO-263	КТТ	5		TBD	Call TI	Call TI
REG104FA-5/500	ACTIVE	DDPAK/ TO-263	КТТ	5	500	Green (RoHS & no Sb/Br)	Call TI	Level-2-260C-1 YEAR
REG104FA-5KTTT	ACTIVE	DDPAK/ TO-263	ктт	5	50	Green (RoHS & no Sb/Br)	Call TI	Level-2-260C-1 YEAR
REG104FA-A	OBSOLETE	DDPAK/ TO-263	ктт	5	TW	TBD	Call TI	Call TI
REG104FA-A/500	ACTIVE	DDPAK/ TO-263	KTT	5	500	Green (RoHS & no Sb/Br)	Call TI	Level-2-260C-1 YEAR
REG104FA-AKTTT	ACTIVE	DDPAK/ TO-263	KTT	5	50	Green (RoHS & no Sb/Br)	Call TI	Level-2-260C-1 YEAR
REG104GA-2.5	NRND	SOP	DCQ	6	78	Green (RoHS & no Sb/Br)	Call TI	Level-2-260C-1 YEAR
REG104GA-2.5/2K5	NRND	SOP	DCQ	6	2500	Green (RoHS & no Sb/Br)	Call TI	Level-2-260C-1 YEAR
REG104GA-2.7	ACTIVE	SOP	DCQ	6	78	Green (RoHS & no Sb/Br)	Call TI	Level-2-260C-1 YEAR
REG104GA-2.7/2K5	ACTIVE	SOP	DCQ	6	2500	Green (RoHS & no Sb/Br)	Call TI	Level-2-260C-1 YEAR
REG104GA-2.7/2K5G4	ACTIVE	SOP	DCQ	6	2500	Green (RoHS & no Sb/Br)	Call TI	Level-2-260C-1 YEAR



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PACKAGE OPTION ADDENDUM

22-Sep-2005

Status (1)	Package Type	Package Drawing	Pins	Package Qty	e Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾	
ACTIVE	SOP	DCQ	6	78	Green (RoHS & no Sb/Br)	Call TI	Level-2-260C-1 YEAR	
NRND	SOP	DCQ	6	78	Green (RoHS & no Sb/Br)	Call TI	Level-2-260C-1 YEAR	
ACTIVE	SOP	DCQ	6	78	Green (RoHS & no Sb/Br)	Call TI	Level-2-260C-1 YEAR	
ACTIVE	SOP	DCQ	6	2500	Green (RoHS & no Sb/Br)	Call TI	Level-2-260C-1 YEAR	
ACTIVE	SOP	DCQ	6	2500	Green (RoHS & no Sb/Br)	Call TI	Level-2-260C-1 YEAR	
NRND	SOP	DCQ	6	2500	Green (RoHS & no Sb/Br)	Call TI	Level-2-260C-1 YEAR	
ACTIVE	SOP	DCQ 🕥	6	2500	Green (RoHS & no Sb/Br)	Call TI	Level-2-260C-1 YEAR	
ACTIVE	SOP	DCQ	6	78	Green (RoHS & no Sb/Br)	Call TI	Level-2-260C-1 YEAR	
ACTIVE	SOP	DCQ	6	2500	Green (RoHS & no Sb/Br)	Call TI	Level-2-260C-1 YEAR	
ACTIVE	SOP	DCQ	6	2500	Green (RoHS & no Sb/Br)	Call TI	Level-2-260C-1 YEAR	
ACTIVE	SOP	DCQ	6	78	Green (RoHS & no Sb/Br)	Call TI	Level-2-260C-1 YEAR	
ACTIVE	SOP	DCQ	6	2500	Green (RoHS & no Sb/Br)	Call TI	Level-2-260C-1 YEAR	
ACTIVE	SOP	DCQ	6	2500	Green (RoHS & no Sb/Br)	Call TI	Level-2-260C-1 YEAR	
	ACTIVE NRND ACTIVE ACTIVE	Type ACTIVE SOP NRND SOP ACTIVE SOP	Type Drawing ACTIVE SOP DCQ NRND SOP DCQ ACTIVE SOP DCQ	Type Drawing ACTIVE SOP DCQ 6 NRND SOP DCQ 6 ACTIVE SOP DCQ 6 ACTIVE SOP DCQ 6 ACTIVE SOP DCQ 6 NRND SOP DCQ 6 ACTIVE SOP DCQ 6	Type Drawing Qty ACTIVE SOP DCQ 6 78 NRND SOP DCQ 6 78 ACTIVE SOP DCQ 6 78 ACTIVE SOP DCQ 6 2500 ACTIVE SOP DCQ 6 2500 NRND SOP DCQ 6 2500 ACTIVE SOP DCQ 6 78 ACTIVE SOP DCQ 6 2500	NRND SOP DCQ 6 78 Green (RoHS & no Sb/Br)	NRND SOP DCQ 6 78 Green (RoHS & Call TI no Sb/Br)	

⁽¹⁾ The marketing status values are defined as follows:

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TBD: The Pb-Free/Green conversion plan has not been defined.

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(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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22-Sep-2005

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27-Sep-2005

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp (3)		
REG104GA-3	NRND	SOP	DCQ	6	78	TBD	Call TI	Call TI		
REG104GA-3.3	ACTIVE	SOP	DCQ	6	78	TBD	Call TI	Call TI		
REG104GA-3.3/2K5	ACTIVE	SOP	DCQ	6	2500	TBD	Call TI	Call TI		
REG104GA-3.3/2K5G4	ACTIVE	SOP	DCQ	6	2500	TBD	Call TI	Call TI		
REG104GA-3/2K5	NRND	SOP	DCQ	6	2500	TBD	Call TI	Call TI		
REG104GA-3/2K5G4	ACTIVE	SOP	DCQ	6	2500	TBD	Call TI	Call TI		
REG104GA-5	ACTIVE	SOP	DCQ	6	78	TBD	Call TI	Call TI		
REG104GA-5/2K5	ACTIVE	SOP	DCQ	6	2500	TBD	Call TI	Call TI		
REG104GA-5/2K5G4	ACTIVE	SOP	DCQ	6	2500	TBD	Call TI	Call TI		
REG104GA-A	ACTIVE	SOP	DCQ	6	78	TBD	Call TI	Call TI		
REG104GA-A/2K5	ACTIVE	SOP	DCQ (6	2500	TBD	Call TI	Call TI		
REG104GA-A/2K5G4	ACTIVE	SOP	DCQ	6	2500	TBD	Call TI	Call TI		
				# A .	4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4	7.		- 411117		

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

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(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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PACKAGE OPTION ADDENDUM

28-Nov-2005

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	e Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
REG104FA-2.5	OBSOLETE	DDPAK/ TO-263	KTT	5	COM	TBD	Call TI	Call TI
REG104FA-2.5/500	NRND	DDPAK/ TO-263	KTT	105	500	Green (RoHS & no Sb/Br)	Call TI	Level-2-260C-1 YEAR
REG104FA-2.5KTTT	NRND	DDPAK/ TO-263	KTT	5	50	Green (RoHS & no Sb/Br)	Call TI	Level-2-260C-1 YEAR
REG104FA-2.7	OBSOLETE	DDPAK/ TO-263	KTT	5	ony.C	TBD	Call TI	Call TI
REG104FA-2.7KTTT	ACTIVE	DDPAK/ TO-263	KTT	5	50	Green (RoHS & no Sb/Br)	Call TI	Level-2-260C-1 YEAR
REG104FA-3	OBSOLETE	DDPAK/ TO-263	KTT	5	N.100Y	TBD	Call TI	Call TI
REG104FA-3.3	OBSOLETE	DDPAK/ TO-263	KTT	5	W.100	TBD	Call TI	Call TI
REG104FA-3.3/500	ACTIVE	DDPAK/ TO-263	KTT	5	500	Green (RoHS & no Sb/Br)	Call TI	Level-2-260C-1 YEAR
REG104FA-3.3KTTT	ACTIVE	DDPAK/ TO-263	KTT	5	50	Green (RoHS & no Sb/Br)	Call TI	Level-2-260C-1 YEAR
REG104FA-3/500	NRND	DDPAK/ TO-263	KTT	5 <	500	Green (RoHS & no Sb/Br)	Call TI	Level-2-260C-1 YEAR
REG104FA-3/500G3	ACTIVE	DDPAK/ TO-263	KTT	5	500	Green (RoHS & no Sb/Br)	Call TI	Level-2-260C-1 YEAR
REG104FA-3KTTT	NRND	DDPAK/ TO-263	KTT	5	50	Green (RoHS & no Sb/Br)	Call TI	Level-2-260C-1 YEAR
REG104FA-3KTTTG3	ACTIVE	DDPAK/ TO-263	KTT	5	50	Green (RoHS & no Sb/Br)	Call TI	Level-2-260C-1 YEAR
REG104FA-5	OBSOLETE	DDPAK/ TO-263	КТТ	5		TBD	Call TI	Call TI
REG104FA-5/500	ACTIVE	DDPAK/ TO-263	KTT	5	500	Green (RoHS & no Sb/Br)	Call TI	Level-2-260C-1 YEAR
REG104FA-5/500G3	ACTIVE	DDPAK/ TO-263	KTT	5	500	Green (RoHS & no Sb/Br)	Call TI	Level-2-260C-1 YEAR
REG104FA-5KTTT	ACTIVE	DDPAK/ TO-263	KTT	5	50	Green (RoHS & no Sb/Br)	Call TI	Level-2-260C-1 YEAR
REG104FA-A	OBSOLETE	DDPAK/ TO-263	ктт	5	TW	TBD	Call TI	Call TI
REG104FA-A/500	ACTIVE	DDPAK/ TO-263	KTT	5	500	Green (RoHS & no Sb/Br)	Call TI	Level-2-260C-1 YEAR
REG104FA-AKTTT	ACTIVE	DDPAK/ TO-263	KTT	50	50	Green (RoHS & no Sb/Br)	Call TI	Level-2-260C-1 YEAR
REG104GA-2.5	NRND	SOT-223	DCQ	6	78	Green (RoHS & no Sb/Br)	Call TI	Level-2-260C-1 YEAR
REG104GA-2.5/2K5	NRND	SOT-223	DCQ	6	2500	Green (RoHS & no Sb/Br)	Call TI	Level-2-260C-1 YEAR
REG104GA-2.5G4	ACTIVE	SOT-223	DCQ	6	78	Green (RoHS & no Sb/Br)	Call TI	Level-2-260C-1 YEAR
REG104GA-2.7	ACTIVE	SOT-223	DCQ	6	78	Green (RoHS & no Sb/Br)	Call TI	Level-2-260C-1 YEAR
REG104GA-2.7G4	ACTIVE	SOT-223	DCQ	6	78	Green (RoHS & no Sb/Br)	Call TI	Level-2-260C-1 YEAR



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PACKAGE OPTION ADDENDUM

28-Nov-2005

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp (3)
REG104GA-3	NRND	SOT-223	DCQ	6	78	Green (RoHS & no Sb/Br)	Call TI	Level-2-260C-1 YEAR
REG104GA-3.3	ACTIVE	SOT-223	DCQ	6	78	Green (RoHS & no Sb/Br)	Call TI	Level-2-260C-1 YEAR
REG104GA-3.3/2K5	ACTIVE	N SOT-223	DCQ	106 1	2500	Green (RoHS & no Sb/Br)	Call TI	Level-2-260C-1 YEAR
REG104GA-3.3/2K5G4	ACTIVE	SOT-223	DCQ	16	2500	Green (RoHS & no Sb/Br)	Call TI	Level-2-260C-1 YEAR
REG104GA-3.3G4	ACTIVE	SOT-223	DCQ	6	78	Green (RoHS & no Sb/Br)	Call TI	Level-2-260C-1 YEAR
REG104GA-3/2K5G4	ACTIVE	SOT-223	DCQ	6	· V	TBD	Call TI	Call TI
REG104GA-3G4	ACTIVE	SOT-223	DCQ	6	78	Green (RoHS & no Sb/Br)	Call TI	Level-2-260C-1 YEAR
REG104GA-5	ACTIVE	SOT-223	DCQ	6	78	Green (RoHS & no Sb/Br)	Call TI	Level-2-260C-1 YEAR
REG104GA-5/2K5	ACTIVE	SOT-223	DCQ	6	2500	Green (RoHS & no Sb/Br)	Call TI	Level-2-260C-1 YEAR
REG104GA-5/2K5G4	ACTIVE	SOT-223	DCQ	6	2500	Green (RoHS & no Sb/Br)	Call TI	Level-2-260C-1 YEAR
REG104GA-5G4	ACTIVE	SOT-223	DCQ	6	78	Green (RoHS & no Sb/Br)	Call TI	Level-2-260C-1 YEAR
REG104GA-A	ACTIVE	SOT-223	DCQ	6	78	Green (RoHS & no Sb/Br)	Call TI	Level-2-260C-1 YEAR
REG104GA-A/2K5	ACTIVE	SOT-223	DCQ	6	2500	Green (RoHS & no Sb/Br)	Call TI	Level-2-260C-1 YEAR
REG104GA-A/2K5G4	ACTIVE	SOT-223	DCQ	6	2500	Green (RoHS & no Sb/Br)	Call TI	Level-2-260C-1 YEAR
		1 (N) F.	- 11	4.	4.	-x1 100 '	27/1.1	

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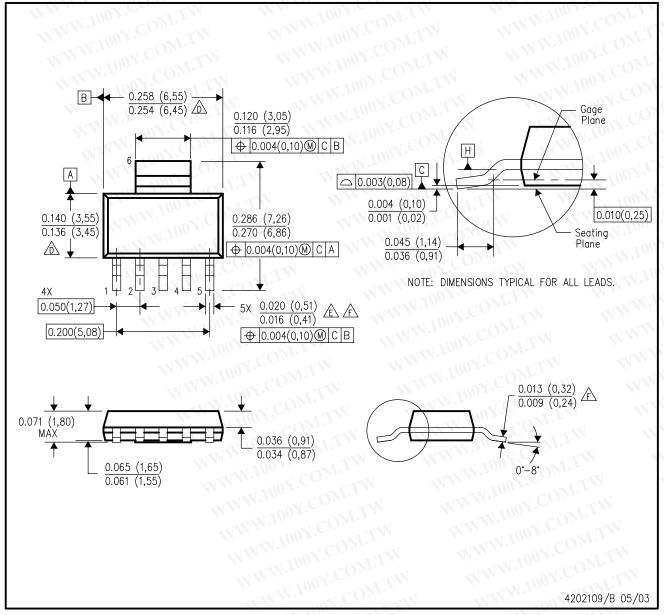
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DCQ (R-PDSO-G6)

PLASTIC SMALL-OUTLINE



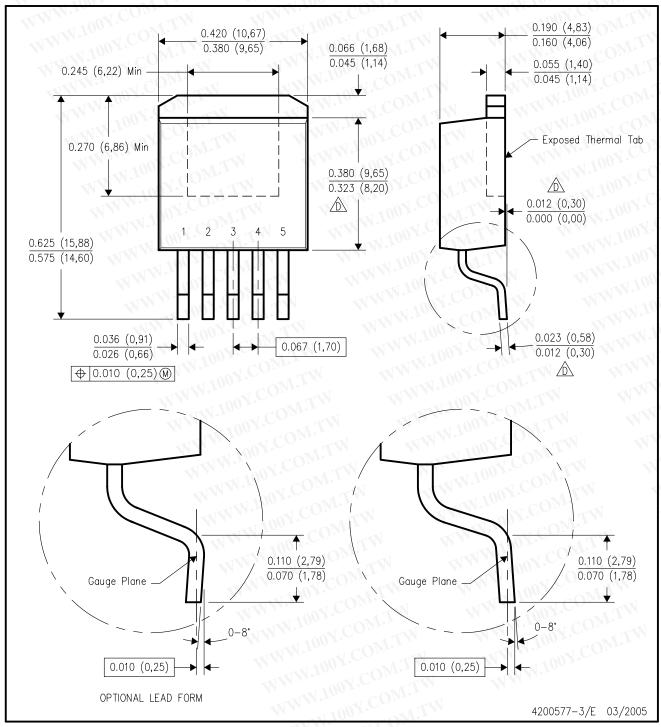
NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Controlling dimension in inches.
- Body length and width dimensions are determined at the outermost extremes of the plastic body exclusive of mold flash, tie bar burrs, gate burrs, and interlead flash, but including any mismatch between the top and the bottom of the plastic body.
- Lead width dimension does not include dambar protrusion.
- Lead width and thickness dimensions apply to solder plated leads.
- G. Interlead flash allow 0.008 inch max.
- H. Gate burr/protrusion max. 0.006 inch.
- I. Datums A and B are to be determined at Datum H.
- J. Package dimensions per JEDEC outline drawing T0-261, issue B, dated Feb. 1999. This variation is not yet included.



KTT (R-PSFM-G5)

PLASTIC FLANGE-MOUNT PACKAGE



NOTES: A.

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion. Mold flash or protrusion not to exceed 0.005 (0,13) per side.
- Falls within JEDEC TO-263 variation BA, except minimum lead thickness, maximum seating height, and minimum body length.

